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Calendar of Events

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I CALENDAR OF EVENTS

Meeting

ACHEMA 2009, 29th International Exhibition-Congress for Chemical Engineering, Environmental Protection and Biotechnology, Frankfurt am Main, Germany, 11–15 May 2009

World Technology Summit of the Process Industry

Around 4,000 exhibitors from all continents, 180,000 visitors from 100 different countries and 30,000 executives from the top two levels of management will meet at ACHEMA 2009 in Frankfurt am Main from 11 to 15 May. The process industry – the chemical industry, biotechnology, the pharmaceutical and food industries, environmental technology, materials technology and energy production constantly faces new challenges; they can only be overcome by focused interaction between the various disciplines. These synergies explain why many companies seize this opportunity to present their innovations and technological trends at ACHEMA.

New Technologies Secure the Future of the Branch

ACHEMA is the summit of the process industry, the “Who’s Who” in research and industry. It represents the major international industry gathering, presenting an impressive, comprehensive array of technologies. Moreover the two integral general topics of ACHEMA, environmental protection and biotechnological equipment, demonstrate the full range of technical solutions.

ACHEMA Congress – Experts, Executives and End-users Face-to-face

The Congress program encompasses 900 lectures and, side by side with the exhibition, represents a second cornerstone of ACHEMA. Numerous special and guest events, panel discussions, expert round tables and plenary lectures reflect the infinite variety of process technology. Parallel to the exhibition the ACHEMA Congress spans the complete spectrum of process engineering and complements the classical aspects with a number of special, highly topical lecture series.

For all information and services for exhibitors and visitors, visit www.achema.de

Announcement and Call for Papers 3rd International Conference ACE-X 2009: Special session 'Adhesive Bonding'.

The 3rd International Conference ACE-X 2009 will take place in Rome, Italy, 22–23 June 2009. The conference will be held in the Grand Hotel Palazzo Carpegna located a few minutes from the Vatican City and Rome city centre. The conference is co-chaired by Andreas Öchsner (Malaysia), Lucas F. M. da Silva (Portugal) and H Altenbach (Germany), and will deal with topics related to Advanced Computational Engineering and Experimenting. As in the previous ACE-X conferences, there will be a special session about 'Adhesive Bonding.' The 'Adhesive Bonding' special session is co-organized by Lucas F. M. da Silva (Portugal) and Luca Goglio (Italy). The scientific committee of the 'Adhesive Bonding' special session includes R. D. Adams (UK), Chiaki Sato (Japan), Erol Sancaktar (USA), Gary Critchlow (UK), Hyun-Joong Kim (South Korea), Ian Ashcroft (UK), Jean-Yves Cognard (France), JC Suarez (Spain), Liyong Tong (Australia), Marcelo de Moura (Portugal), Toshiyuki Sawa (Japan) and W Possart (Germany).

The following aspects of adhesive bonding will be covered, among others:

Fundamental aspects of adhesion; the science and technology of surfaces; advances in adhesive materials; mechanical properties of bonded joints; innovative designs and applications; testing and standardization; industrial aspects; quality procedures; environmental and ecological aspects; bio-adhesion.

Authors who wish to make a presentation (oral or poster) are requested to submit a short abstract (one single A4 page possibly with a diagram and references) in English, by 27 March 2009, in the web site of the conference <http://ace-x2009.com/abstract.html>.

Important Dates:

- 27 March 2009 Abstract submission deadline
- 03 April 2009 Notification of acceptance to authors
- 17 April 2009 Early bird registration
- 20 April 2009 Accommodation reservation

The accepted abstracts submitted to ACE-X 2009 will be published in the Book of Abstracts which will be available to delegates at registration upon the start of the conference.

Selected papers of the 'Adhesive Bonding' special session will be published in the Journal of Adhesion Science and Technology, The Journal of Adhesion and International Journal of Adhesion and Adhesives. Full length papers should be submitted at the conference site (two hard copies and pdf file).

The organisers will select the most appropriate journal and deal with the review process.

More information is available through:

The web page of the Conference: www.ace-x2009.com

Lucas F. M. da Silva: Faculdade de Engenharia, Universidade do Porto, Rua Dr. Roberto Frias, 4200-465 Porto, Portugal, Tel: +351 22 5081706, Fax: +351 22 5081445, E-mail: lucas@fe.up.pt

Luca Goglio: Dipartimento di Meccanica, Politecnico di Torino, Corso Duca degli Abruzzi 24, 10129 Torino, Italy, Tel: +390115646934, Fax: +390115646999, E-mail: luca.goglio@polito.it

Announcement and Call for Papers

September 28–30, 2009, Harveys Resort Hotel & Casino, South Lake Tahoe, Nevada, USA.

The ninth in a series of conferences sponsored every 4–5 years by the USDA Forest Service, Forest Products Laboratory and Forest Products Society, designed to provide a comprehensive update of the science and technology of wood adhesives and bonded wood products. The conferences will be held in conjunction with ASTM International D 14.30 Wood Adhesives Subcommittee on October 1, 2009.

Information transfer during the 3-day conference will take place via plenary, technical and poster presentations and tabletop exhibits on the following subject areas:

- Formaldehyde and environmental issues
- Biobased adhesives
- Resin chemistry
- Analytical methods
- Composites
- Engineered wood structures
- Modeling
- Other topics

This conference is sponsored by the USDA Forest Service, Forest Products Laboratory and Forest Products Society. To submit a formal

or poster abstract electronically or for the most recent information on the program, please visit FPS online at:

www.forestprod.org/confadhesives09.html

Paper Abstracts are due December 15, 2008.

For more information, contact the Forest Products Society, 2801 Marshall Court, Madison, WI 53705-2295, USA:

Phone: 608-231-1361; Fax: 608-231-2152; E-mail: conferences@forestprod.org.

Web site: www.forestprod.org